

Front End Electronics (FEE 2014)

Wednesday 21 May 2014

3D Integration Session II - Energy Sciences Building (15:45 - 16:35)

-Conveners: Takaki Hatsui

time	[id] title	presenter
15:45	[25] Towards a 3D AGIPD	MARRAS, Alessandro
16:10	[26] 3D CMOS Sensors with Two Layers in the 180nm Tower/Jazz Process	DULINSKI, Wojciech